

# AOZ8S312BD4

4-Channel Ultra-Low Capacitance TVS Diode Array

## **General Description**

The AOZ8S312BD4 is a transient voltage suppressor array designed to protect high speed data lines such as HDMI 1.4/2.0, USB 3.2, LVDS, and V-by-one from damaging ESD events.

This device incorporates a numbers of surge rated, low capacitance steering diodes and a TVS in a single package. During transient conditions, the steering diodes direct the transient to either the positive side of the power supply line or to ground.

The AOZ8S312BD4 provides a typical capacitance of 0.28 pF and low insertion loss providing greater signal integrity making it ideally suited for HDMI 1.4/2.0 or USB 3.2 applications, such as Digital TVs, DVD players, computing, set-top boxes and MDDI applications in mobile computing devices.

The AOZ8S312BD4 comes in a RoHS compliant and Halogen Free 2.5 mm x 1.0 mm x 0.55 mm DFN-10 package and is rated for -40 $^{\circ}$ C to +125 $^{\circ}$ C junction temperature range.

#### **Features**

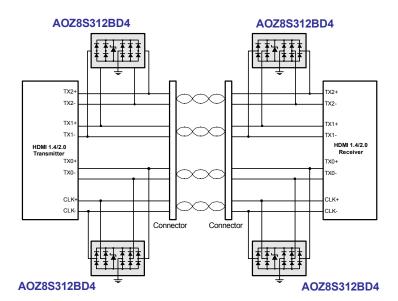
- IEC 61000-4-2 (ESD):
  - Air discharge: ±15 kV
  - Contact discharge: ±15 kV
- IEC 61000-4-5 (Lightning, 8/20 μs) 5 A
- Human Body Model (HBM) ±8 kV
- Protects four I/O lines
- Low capacitance between I/O to GND: 0.28 pF
- Low clamping voltage
- Low operating voltage: 3.3 V, 5 V

## **Applications**

- HDMI 1.4/2.0, USB 3.2, Thunderbolt, V-by-One
- Monitors and flat panel displays
- Set-top box
- Video graphics cards
- Notebook computers



# **Typical Applications**





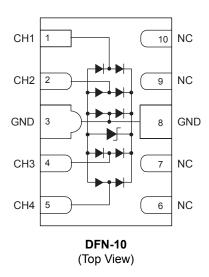
# **Ordering Information**

Part Number Ambient Temperature Range		Package	Environmental		
AOZ8S312BD4-03	-40°C to +125°C	2.5 mm x 1.0 mm DFN-10	Green Product		
AOZ8S312BD4-05	-40°C to +125°C	2.5 mm x 1.0 mm DFN-10	Green Product		



AOS Green Products use reduced levels of Halogens, and are also RoHS compliant. Please visit www.aosmd.com/media/AOSGreenPolicy.pdf for additional information.

# **Pin Configuration**



## **Absolute Maximum Ratings**

Exceeding the Absolute Maximum ratings may damage the device.

Parameter	Rating		
Storage Temperature (T <sub>S</sub> )	-65 °C to +150 °C		
ESD Rating per IEC 61000-4-2, contact <sup>(1)</sup>	±15 kV		
ESD Rating per IEC 61000-4-2, air <sup>(1)</sup>	±15 kV		
ESD Rating per Human Body Model <sup>(2)</sup>	±8 kV		

### Notes:

- 1. IEC 61000-4-2 discharge with C\_Discharge = 150pF, R\_Discharge = 330  $\Omega.$
- 2. Human Body Discharge per MIL-STD-883, Method 3015  $C_{Discharge}$  = 100 pF,  $R_{Discharge}$  = 1.5 k $\Omega$ .

# **Maximum Operating Ratings**

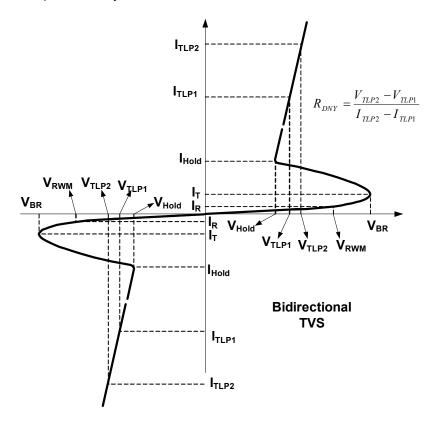
Parameter		Rating
Junction To	emperature (T <sub>J</sub> )	-40 °C to +125 °C

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## **Electrical Characteristics**

 $T_A$  = 25°C unless otherwise specified. Any I/O Pin-to-Ground.



Symbol	Parameter	Conditions	Min.	Тур.	Max	Units
V <sub>RWM</sub>	Reverse Working Voltage	AOZ8S312BD4-03			3.3	V
		AOZ8S312BD4-05			5	V
V <sub>BR</sub>	Reverse Breakdown Voltage	I <sub>T</sub> = 100 μA	6		9	V
I <sub>R</sub>	Reverse Leakage Current	Max. V <sub>RWM</sub>		1	100	nA
V <sub>CL</sub>	Clamping Voltage <sup>(3)(4)</sup> (100 ns Transmission Line Pulse, I/O Pin to GND)	I <sub>TLP</sub> = 1 A I <sub>TLP</sub> = -1 A		2.5 -2.5		V V
		I <sub>TLP</sub> = 16 A I <sub>TLP</sub> = -16 A		6 -6		V V
R <sub>DNY</sub>	Dynamic Resistance <sup>(3)</sup>	I <sub>TLP</sub> = 1A to 16 A		0.45		Ω
С	Junction Capacitance	V <sub>PIN 3,8</sub> = 0 V, V <sub>I/O</sub> = 1.65 V, f = 1 MHz		0.28	0.34	pF
		$V_{PIN 3,8} = 0 \text{ V}, V_{I/O} = 1.65 \text{ V}, f = 1 \text{ MHz},$ I/O Pin-to-I/O Pin <sup>(3)</sup>		0.28		pF

#### Notes:

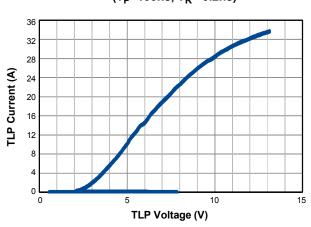
- 3. These specifications are guaranteed by design and characterization.
- 4. Measurements performed using a 100ns Transmission Line Pulse (TLP) system.

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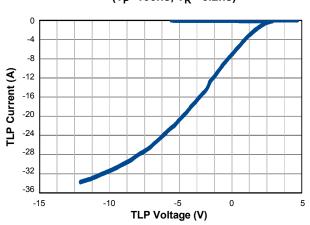


# **Typical Characteristics**

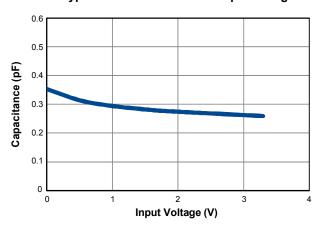
Positive Transmission Line Pulse  $(T_P=100ns, T_R=0.2ns)$ 



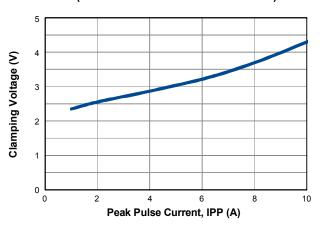
Negative Transmission Line Pulse  $(T_P=100ns, T_R=0.2ns)$ 



Typical Variations of CJ vs. Input Voltage



IEC61000-4-5 Surge 8/20µs (I/O Pin to GND and GND to I/O Pin)

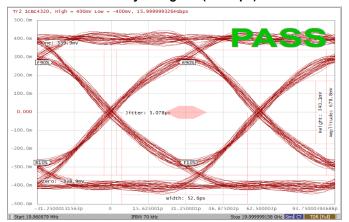


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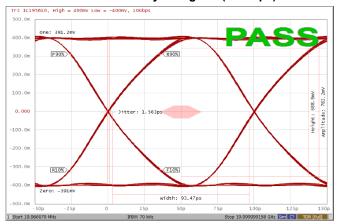


# **Typical Characteristics** (Continued)

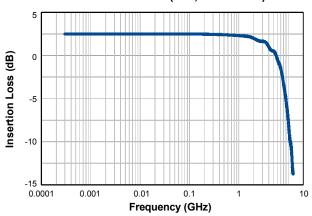
**HDMI Eye-Diagram (16 Gbps)** 



USB 3.1 Gen2 Eye-Diagram (10 Gbps)



Insertion Loss (S21, I/O to GND)



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- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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